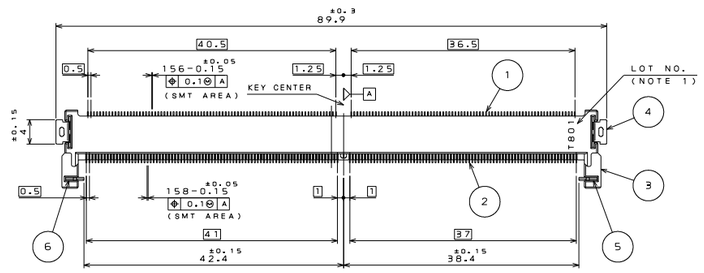
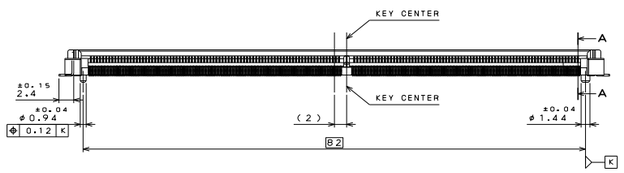
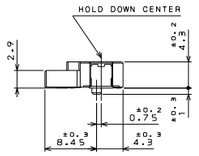
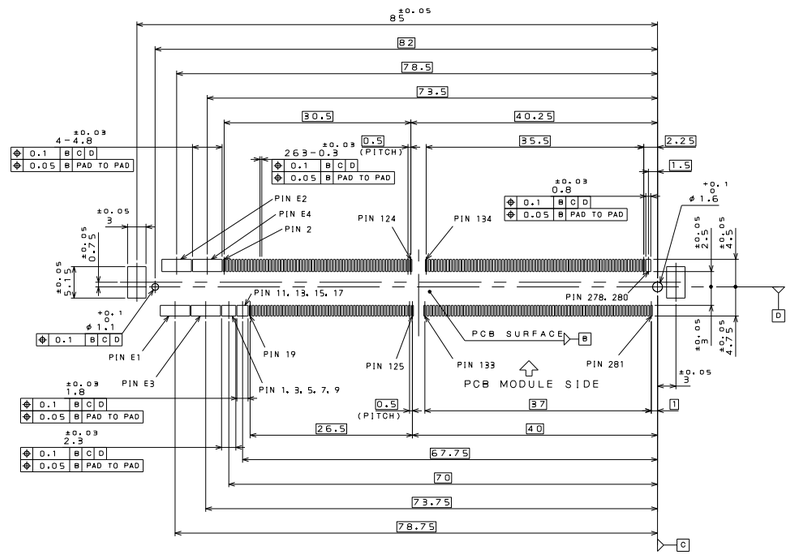
図番号(DRAWING NO.) SJ110715

版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.

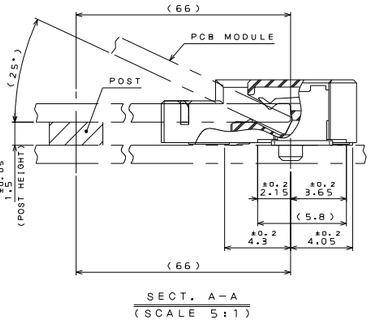




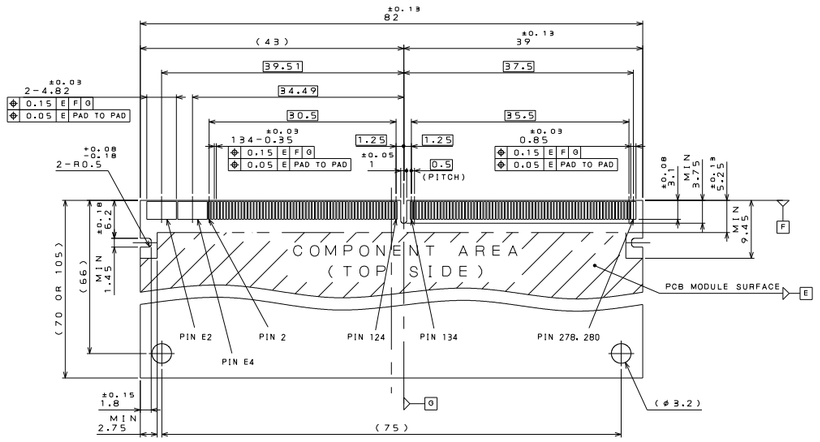


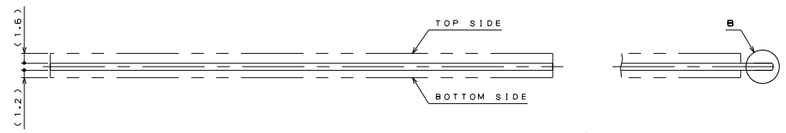


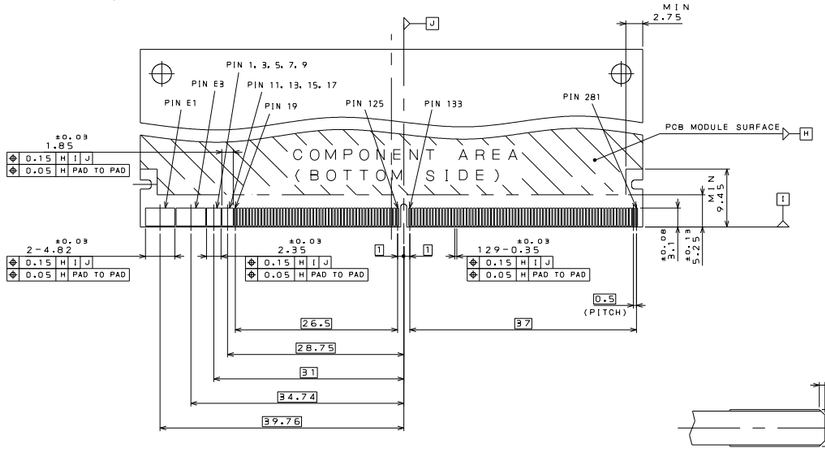
P.C.B. DIMENSION(REF.)
基板寸法(参考)



SECT. A-A
(SCALE 5:1)

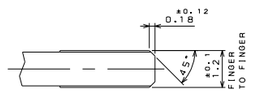






P.C.B. MODULE DIMENSION(REF.)
モジュール基板寸法(参考)

MXM3.0(Rev1.0)



DETAIL B
(SCALE10:1)

DESIGNATION
命名法

MM70-314B2-*

- SERIES PREFIX シリーズ名
- NUMBER OF CONTACTS 芯数
- SOCKET TYPE ソケットタイプ B:ANGLED INSERTION TYPE
- MODIFICATION CODE
- CONTACT FINISH 接点仕上げ 1:GOLD(0.1μm MIN) OVER NICKEL 2:GOLD(0.3μm MIN) OVER NICKEL

NOTE1. PRODUCTION LOT NUMBER AS INDICATED.
2. COPLANALITY OF SMT TERMINAL IS 0.1 MAX.

注1. 図示の面にロット番号を表示する.

(EX.) T801
- PRODUCT CODE 製造コード
- YEAR (LAST DIGIT ONLY) 年表示 (西暦末尾)
- MONTH(RESPECTIVELY. OCT.:0. NOV.:X. DEC.:Y) 月表示(10月:0,11月:X,12月:Y)
- LOT NUMBER OF CURRENT MONTH 当月の生産ロットを示す

2.コンタクトのコプラナリティは0.1以下とする.

符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
6	STOPPER(L)	1	COPPER ALLOY	TIN OVER NICKEL	———
5	STOPPER(R)	1	COPPER ALLOY	TIN OVER NICKEL	———
4	HOLD DOWN	2	COPPER ALLOY	TIN OVER NICKEL	———
3	INSULATOR	1	GLASS FILLED LCP	———	COLOR:BLACK
2	BOTTOM SIDE CONTACT	158	COPPER ALLOY	CONTACT AREA: REFER TO "DESIGNATION" SOLDERING AREA: GOLD FLASH OVER NICKEL	———
1	TOP SIDE CONTACT	156	COPPER ALLOY		———

仕様書(SPECIFICATION)	JACS-10543-2	製図(ORIGINAL DATE)	14.Apr.2010
一般公差(GENERAL TOLERANCE)		製図 DR.	———
寸法(DIMENSION)	角度(ANGLES)	担当 CHK.	H.KOIZUMI
.* ±0.8	X° ± ———	査閲 APPD.	T.TSUJI
.X ±0.4	X°X' ± ———	承認 APPD.	K.NAKAMURA
.XX ±0.1		———	
.XXX ± ———			

R度(SCALE)	2:1
シリーズ(SERIES)	MM70
名称(TITLE)	MM70-314B2-*
質量(MASS)	———
図面番号(DRAWING NO.)	SJ110715
版数(REV.)	1
SIZE	A1

日本航空電子工業株式会社
JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.

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DCF-C-214F(05.08)

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